**PRODUCT CHANGE NOTICE**

<table>
<thead>
<tr>
<th>PART NUMBER(S):</th>
<th>PCN No.: 06-0130-36</th>
</tr>
</thead>
<tbody>
<tr>
<td>Please see attachment.</td>
<td>DATE: January 30, 2006</td>
</tr>
</tbody>
</table>

**PART DESCRIPTION:**

Power Management and Interface Products – Change in Wafer Fabrication Site

**LEVEL OF CHANGE:**

- [X] Level I, Customer Approval.
- [ ] Level II, Customer Information.

**PRODUCT ATTRIBUTE AFFECTED:**

- [ ] Material Change
- [ ] Design Change
- [X] Process Change
- [ ] Data Sheet Change
- [ ] Package Change
- [ ] Packing / Shipping

- [X] Other, Explain: Wafer Fabrication Site Transfer

**DESCRIPTION OF CHANGE:**

Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry Silan. See attached Product List no. 36.

**REASON FOR CHANGE:**

Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.

**FABRICATION PROCESS QUALIFICATION COMPLETED (DATE): October 15, 2006**

**PRODUCT CHARACTERIZATION COMPLETED AND SAMPLES* AVAILABLE (DATE): October 15, 2006**

* Samples representative of product from the Product Family being transferred.
<table>
<thead>
<tr>
<th>PART NUMBER</th>
<th>DESCRIPTION</th>
<th>REV</th>
<th>DATE OF ISSUE</th>
<th>DISTRIBUTION</th>
<th>DATE CODE</th>
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<tbody>
<tr>
<td>X123456</td>
<td>Test Module</td>
<td>A1</td>
<td>2023-01-15</td>
<td>Standard</td>
<td>WORK007</td>
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</table>

**Notes:**
- Standard distribution for general use.
- Custom distribution for specific project requirements.

Contact:
- Fred Claussen, VP Quality Assurance and Reliability, Sipex Corporation, Phone: 408-935-7644, FAX: 408-935-7678.
PCN No.: 06-0130-36

List 36

SP6120CY
SP6120CY-L
SP6120EY
SP6120EY-L
SP6120HEY
SP6120HEY-L
SP6120HY
SP6120HY-L